



RECOMMENDED PC BOARD MOUNTING DIMENSIONS
 FOR .063 [1.60] THICK PC BOARD AND
 .012 [.305] STENCIL THICK.

- 1 ASSEMBLY MAY BE BROKEN TO THE DESIRED NUMBER OF POSITIONS
- 2 TRUE POSITION TOLERANCE OF THE POST TIPS APPLIES WHEN THE HEADER IS HELD FLAT AGAINST THE PRINTED CIRCUIT BOARD
- 3 THE NOTED DIMENSIONS APPLY AT THE INTERSECTION OF THE POST AND HOUSING
- 4 0.00762 [.000030] GOLD IN CONTACT AREA,
 0.00254-0.00508 [.0000100-.0000200] MATTE TIN-LEAD ON SOLDER TAIL,
 ALL OVER 0.00127 [.000050] NICKEL.
- 5 MATERIAL: HOUSING - LCP, COLOR: BLACK.
 POSTS - PHOSPHOR BRONZE
- 6 0.00762 [.000030] GOLD IN CONTACT AREA,
 0.00254-0.00508 [.0000100-.0000200] MATTE TIN ON SOLDER TAIL,
 ALL OVER 0.00127 [.000050] NICKEL.
- 7 OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER DRENAUD/D.SINISI

NO.	DESCRIPTION	DATE	REV. NO.
AD 00	EC 003C 082E 04	18FEB08	BSV/JLG
F1	REVISED PER ECO-10-000443	13JAN10	KK/AEG

NO.	DESCRIPTION	DATE	REV. NO.
101.19	99.06	39	40
3.984	3.900	38	39
98.65	96.52	37	38
3.884	3.800	36	37
96.11	93.98	35	36
3.784	3.700	34	35
93.57	91.44	33	34
3.684	3.600	32	33
91.03	88.90	31	32
3.584	3.500	30	31
88.49	86.36	29	30
3.484	3.400	28	29
85.95	83.82	27	28
3.384	3.300	26	27
83.41	81.28	25	26
3.284	3.200	24	25
80.87	78.74	23	24
3.184	3.100	22	23
78.33	76.20	21	22
3.084	3.000	20	21
75.79	73.66	19	20
2.984	2.900	18	19
73.25	71.12	17	18
2.884	2.800	16	17
70.71	68.58	15	16
2.784	2.700	14	15
68.17	66.04	13	14
2.684	2.600	12	13
65.63	63.5	11	12
2.584	2.500	10	11
63.09	60.96	9	10
2.484	2.400	8	9
60.55	58.42	7	8
2.384	2.300	6	7
58.01	55.88	5	6
2.284	2.200	4	5
55.47	53.34	3	4
2.184	2.100	2	3
52.93	50.80	1	2
2.084	2.000	0	1
50.39	48.26	0	0
1.984	1.900	0	0
47.85	45.72	0	0
1.884	1.800	0	0
45.31	43.18	0	0
1.784	1.700	0	0
42.77	40.64	0	0
1.684	1.600	0	0
40.23	38.10	0	0
1.584	1.500	0	0
37.69	35.56	0	0
1.484	1.400	0	0
35.15	33.02	0	0
1.384	1.300	0	0
32.61	30.48	0	0
1.284	1.200	0	0
30.07	27.94	0	0
1.184	1.100	0	0
27.53	25.40	0	0
1.084	1.000	0	0
24.99	22.86	0	0
0.984	0.900	0	0
22.45	20.32	0	0
0.884	0.800	0	0
19.91	17.78	0	0
0.784	0.700	0	0
17.37	15.24	0	0
0.684	0.600	0	0
14.83	12.70	0	0
0.584	0.500	0	0
12.29	10.16	0	0
0.484	0.400	0	0
9.75	7.62	0	0
0.384	0.300	0	0
7.21	5.08	0	0
0.284	0.200	0	0
4.67	2.54	0	0
0.184	0.100	0	0
2.13	0	0	0
0.084	0	0	0

THIS DRAWING IS A CONTROLLED DOCUMENT.

DATE: 6/12/95
 BY: HOJTMAN
 CHK: DUBINICZKI
 DATE: 3/18/96
 BY: DUBINICZKI

Yoco Electronics
 Headquarters, Pa 17105-3608

DESCRIPTION: HEADER ASSEMBLY, MOD II, BREAKAWAY, SINGLE ROW, HIGH TEMPERATURE, VERTICAL
 W/ .025 SD POSITS, .100 L

APPROVED: [Signature]
 DATE CODE: 00779
 DRAWING NO: 146281

RESTRICTED TO: CUSTOMER DRAWING

SCALE: 4:1
 SHEET: 1 OF 1
 REV: F1